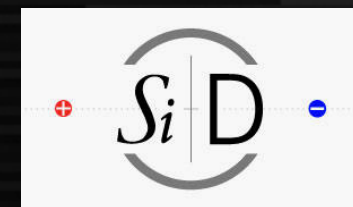


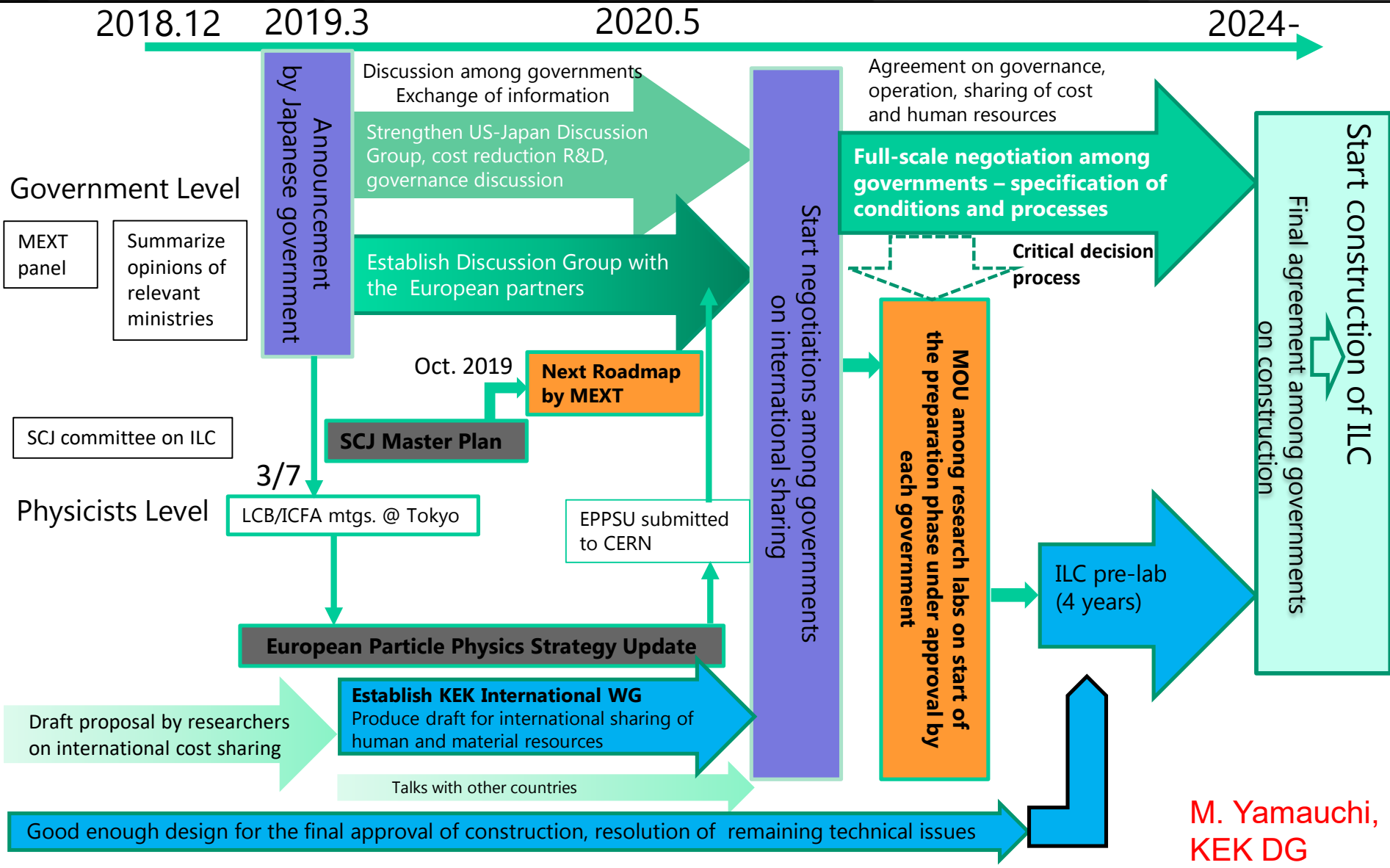


Technologies in ILC detectors

Taikan Suehara
(Kyushu University)



Timeline of ILC towards realization



M. Yamauchi,
KEK DG

Discussions at Granada etc.

All 1st gen Higgs factories have “competitive” performance

- A few times more lumi in circular
- Polarization in linear

of “largely” improved H couplings (EFT)

		Factor ≥ 2	Factor ≥ 5	Factor ≥ 10	Years from T_0
Initial run	CLIC380	9	6	4	7
	FCC-ee240	10	8	3	9
	CEPC	10	8	3	10
	ILC250	10	7	3	11
2 nd /3 rd Run ee	FCC-ee365	10	8	6	15
	CLIC1500	10	7	7	17
	HE-LHC	1	0	0	20
	ILC500	10	8	6	22
hh	CLIC3000	11	7	7	28
ee,eh & hh	FCC-ee/eh/hh	12	11	10	>50

13 quantities in total

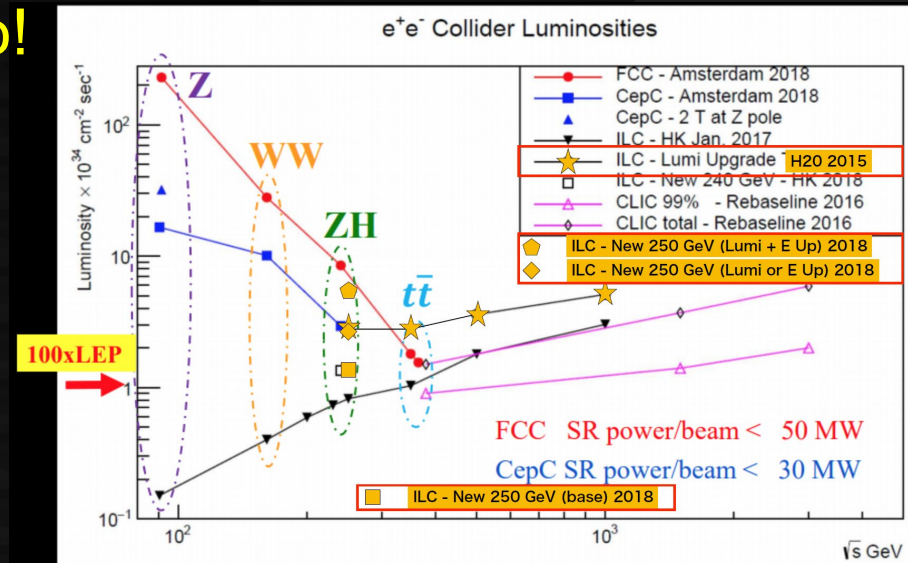
NB: number of seconds/year differs: ILC 1.6×10^7 , FCC-ee & CLIC: 1.2×10^7 , CEPC: 1.3×10^7

e^+e^- collider is the next way to go!

- Linear has energy upgrade
- Circular can be a step for pp

The ILC is the earliest machine if Japan will go timely...

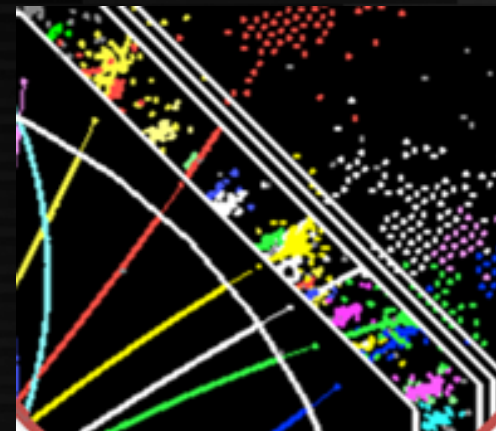
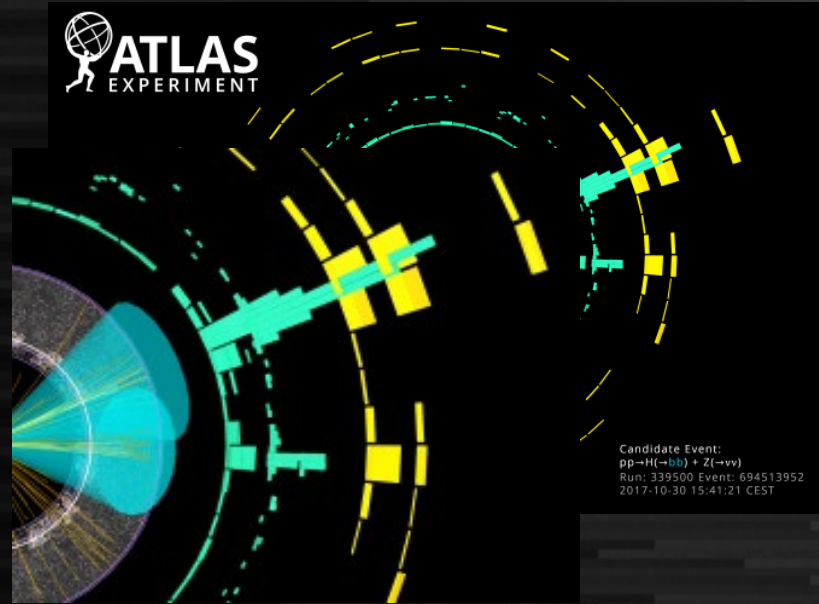
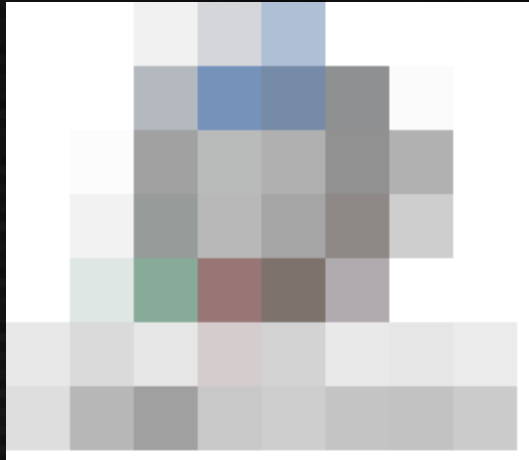
we'll see, but strong worldwide support incl. Korea necessary.



Technologies in ILC detectors



PFA detector: like HR camera



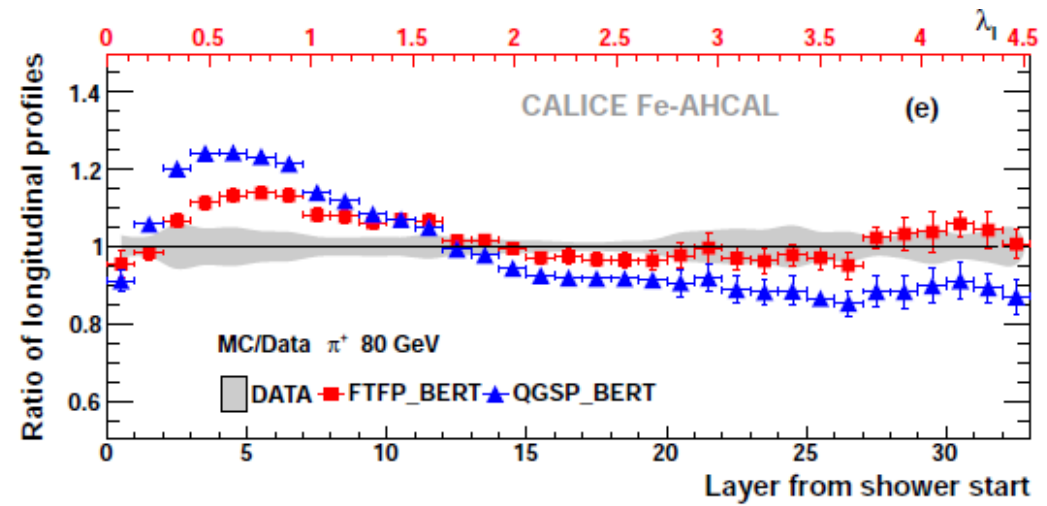
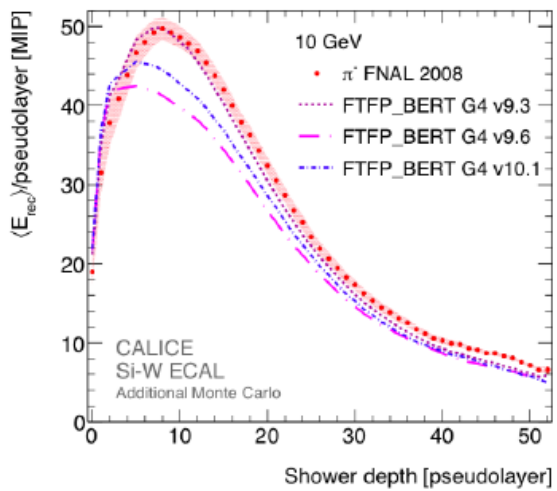
PFA detector: like HR camera



PFA is not only for improving jet energy resolution but we can get “additional dimension” of the events to unveil the nature of the terascale physics!

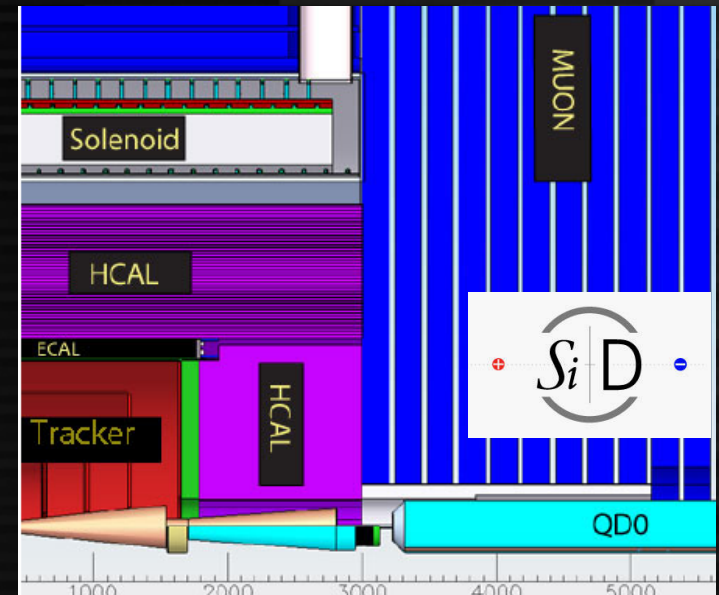
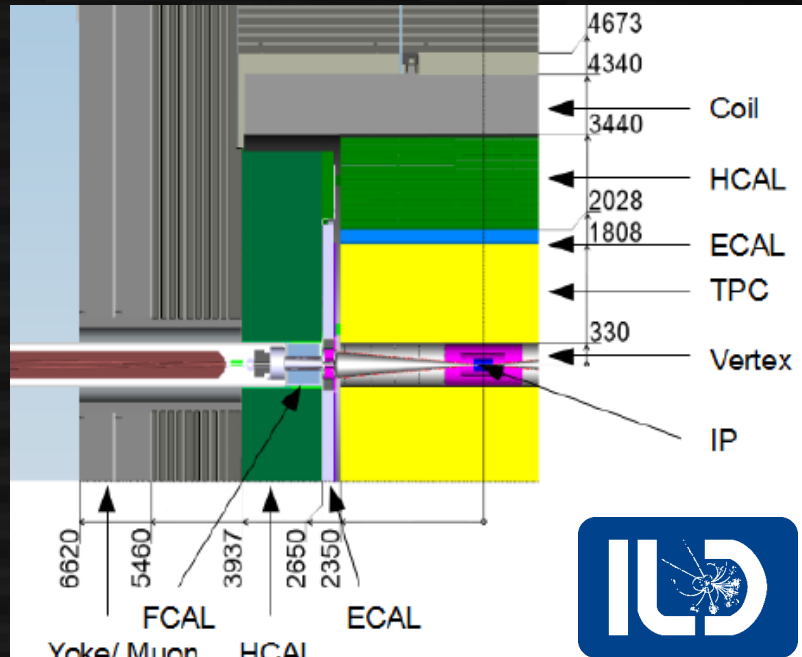
pp→H(→bb)+Z(→vv)
Run: 339500 Event: 694513952
2017-10-30 15:41:21 CEST

One example: CALICE sees deviation of shower profile from MC



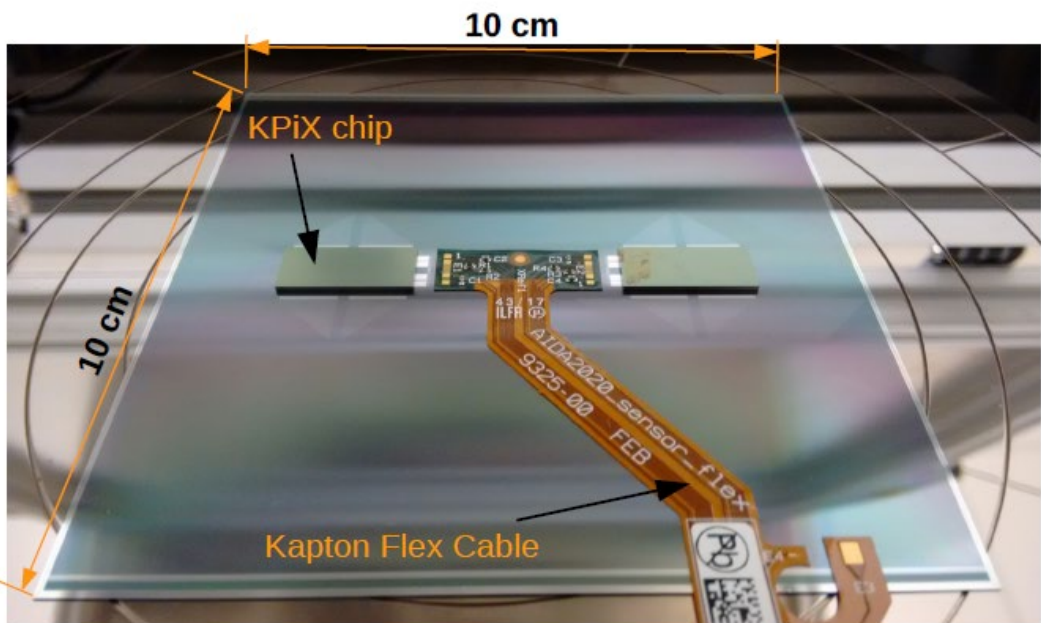
Ingredients of PFA detectors

- Vertex detector
- Tracking (barrel / forward)
 - Silicon
 - TPC
- Very Forward
- ECAL
- HCAL
- Muon



Silicon strips

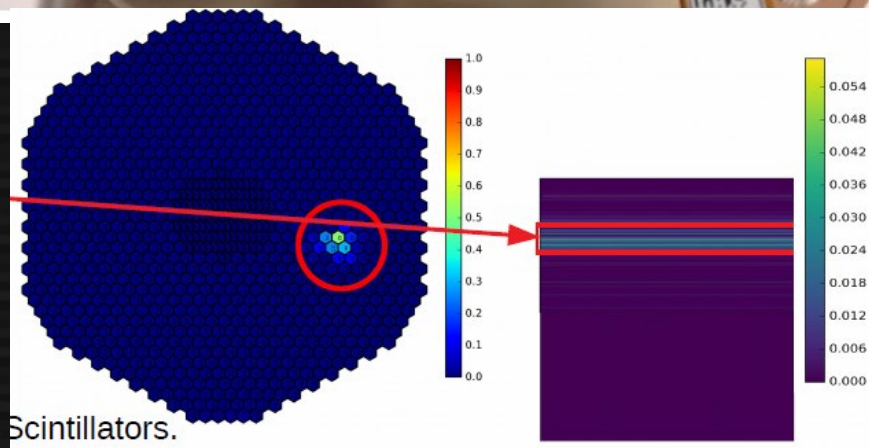
$\sigma_R \sim 7\text{-}10 \mu\text{m}$, $50 \mu\text{m}$ pitch
Material $\sim 0.5\%$ X_0 / layer



First SiD silicon tracker was fabricated with two KPIX ASICs (1024 ch each)

Preparing to be used for AIDA telescope in DESY

Technology of strip mature good for baseline, starting realistic prototyping



Expected Performances

- $\sigma_{sp} \sim 4 \mu\text{m} \Rightarrow$ Use double sided $\Rightarrow \sigma_{sp} \sim 2.8 \mu\text{m}$
 - $22 \times 22 \mu\text{m}^2 \sim 20\%$ better spatial resolution % ALPIDE ()
 - Faster = higher Power consumption
- Read-out time: 2-4 μs (ILD-VXD) and 1 μs (ILD-SIT)

	kPIXM-Trk	kPIXM-Cal
Pixel size	$50 \times 200 \mu\text{m}^2$	$1000 \times 1000 \mu\text{m}^2$
Array	200×2400	100×94
Full size	stitched 5 x 5 reticles	
Max. signal	1 fC	1pC
Effective ENC	$< 200 e^-$	$< 1000 e^-$
S / N	> 20	> 4
in-pixel memory	1 bucket	16 buckets
ADC resolution	12 bits	
DC power consumption	$\sim 20 \mu\text{W}$ / pixel	
power pulsing	yes	

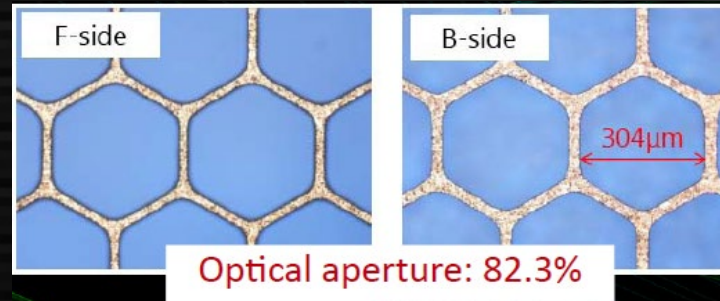
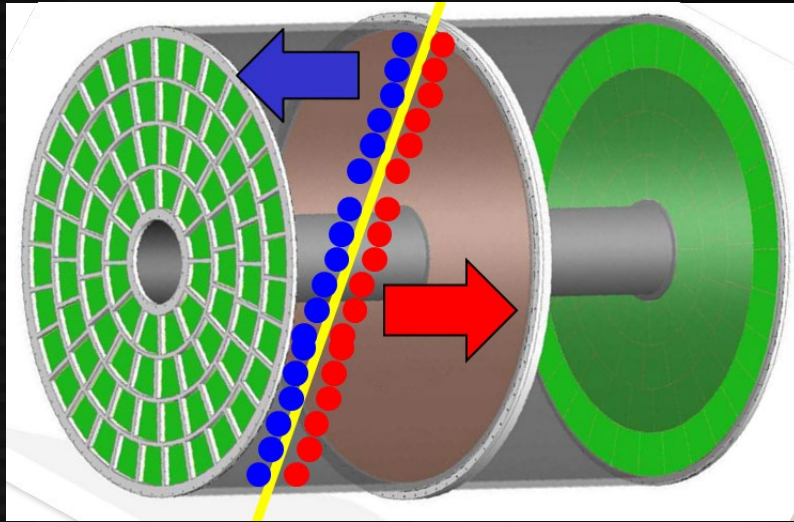
MAPS Pixel option being considered in both ILD & SiD

Concurrent event with tracker

+ ECAL seen

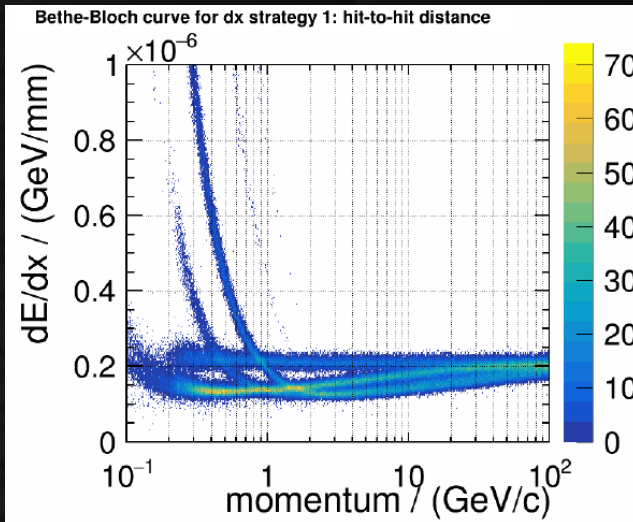
Time Projection Chamber

$\sigma \sim 60 \mu\text{m}$, ~ 200 hits
Material \sim a few % X_0

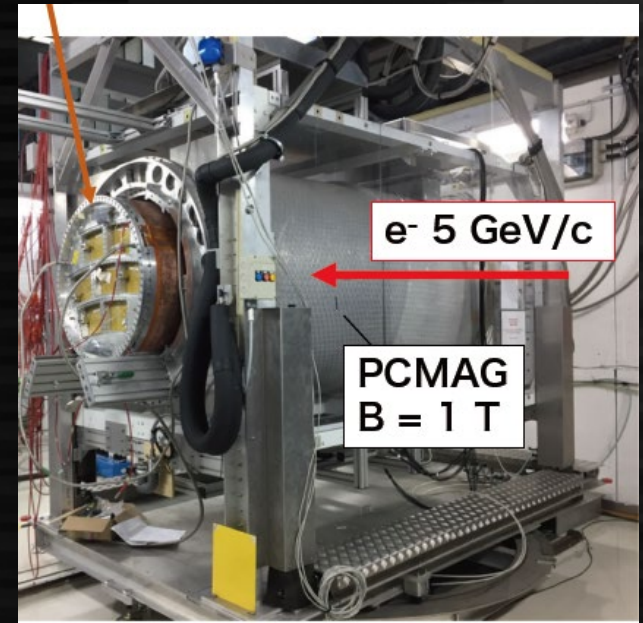


Gating foil for avoiding ion going back to TPC
High optical aperture realized by cooperation with industry

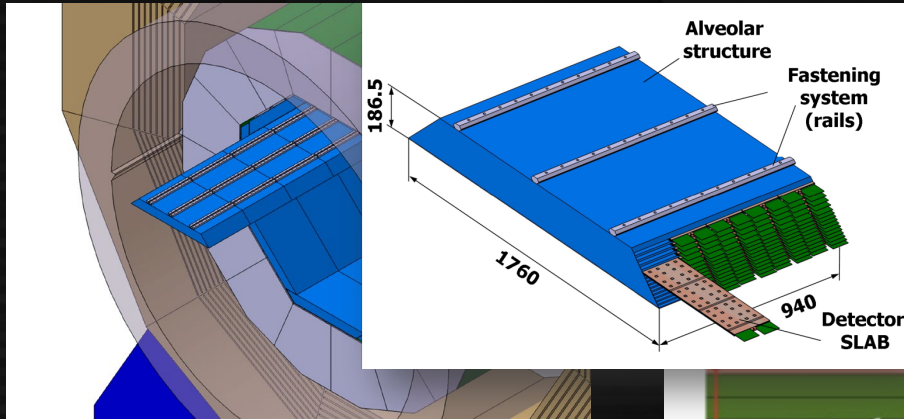
Prototype TPC



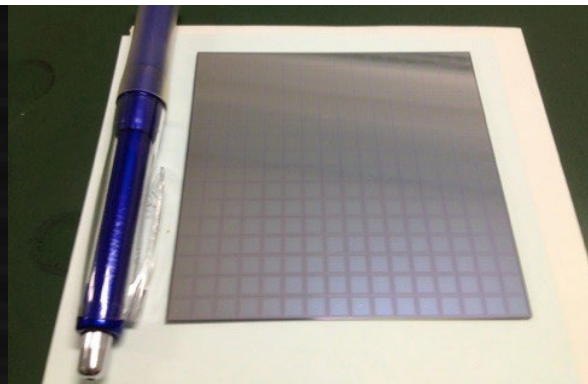
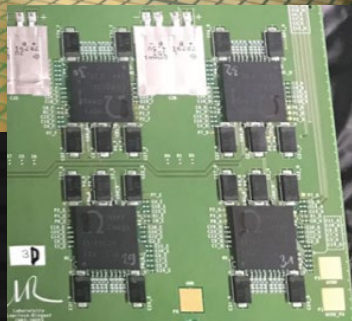
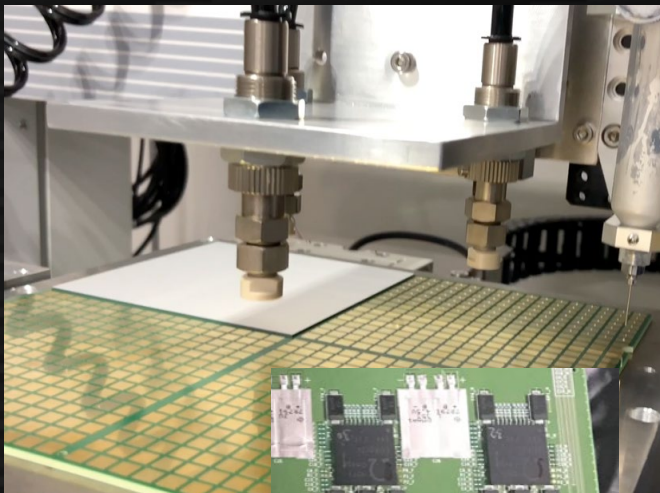
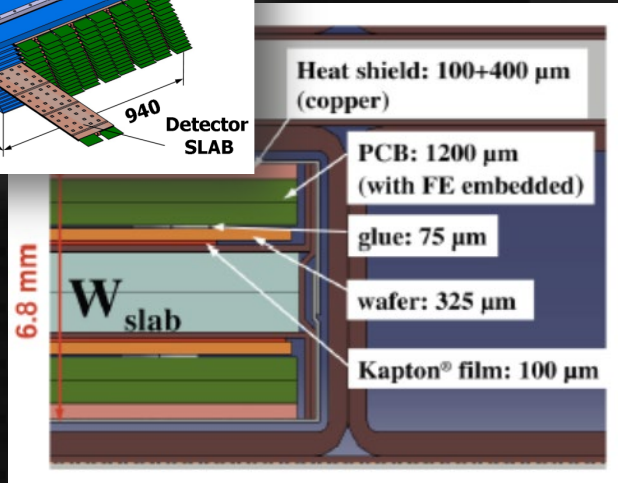
TPC enables the unique dE/dx measurement for particle ID



Silicon-tungsten ECAL



~10⁸ channel
in total: Challenge
on electronics



Silicon pad for ILD ECAL

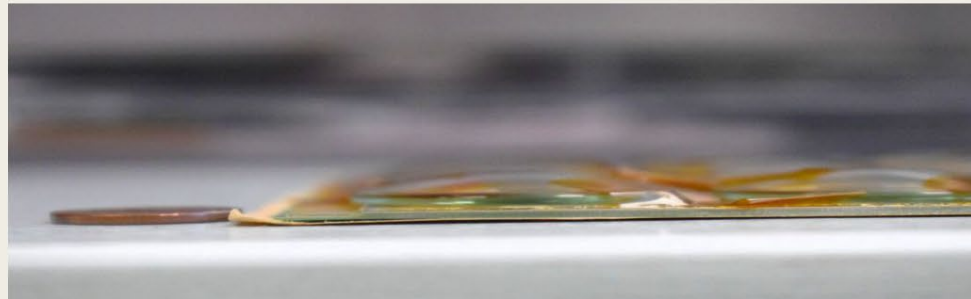
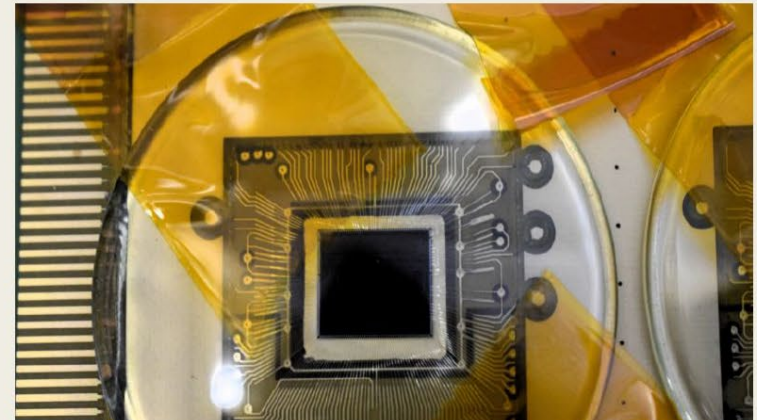


“Long slab”

Korea-France cooperation for SiW-ECAL electronics

- LAL & OMEGA collaboration with ITAEC/SKKU (Sungkyunkwan University, Suwon – Korea) and EOS company for the PCB production.
- 10 FEV11_COB produced.
 - 1.2mm thickness → 9 layers PCB !
 - Good Planarity (metrology made in LAL) and electrical response.
- 4 boards wirebonded at CERN bonding lab. Also In contact with CAPTINNOV Platform.

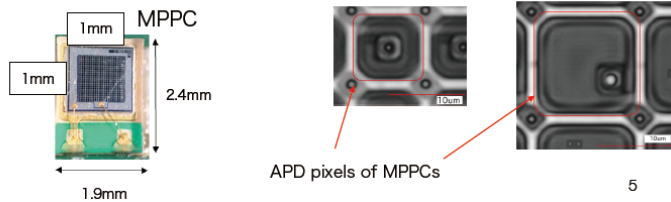
SK2a



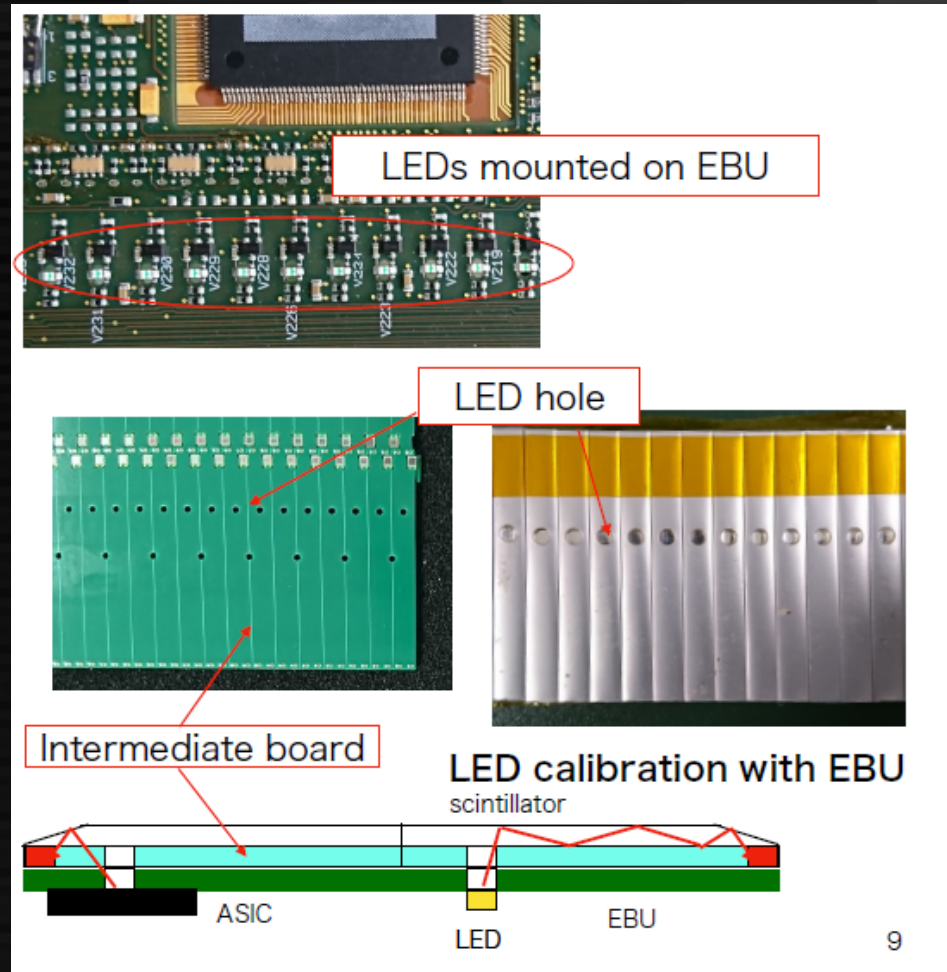
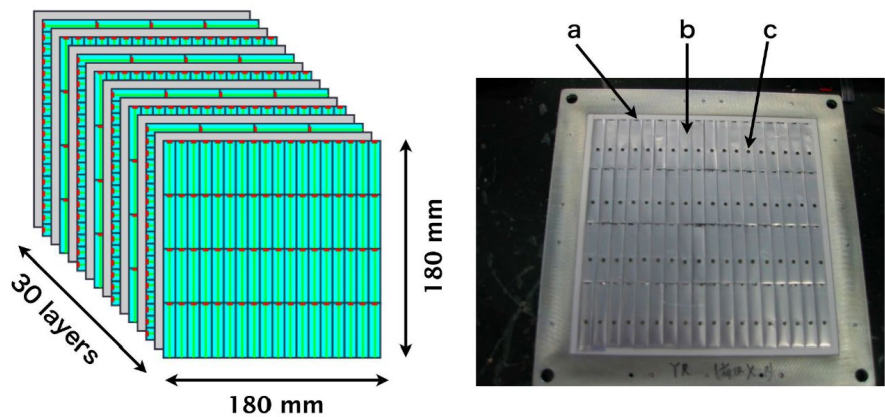
ECAL with strip scintillators

Hamamatsu catalog

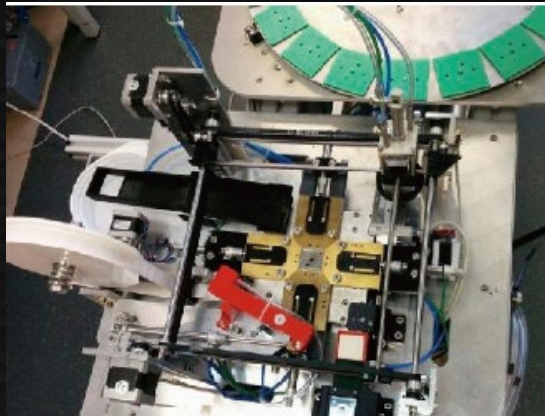
Model Number	S12571-010P	S12571-015P
Photosensitive area	1mm ²	1mm ²
Pixel size	10μm	15μm
Number of pixels	10000	4489
PDE	10%	25%
Gain	1.35x10 ⁵	2.3x10 ⁵
Geometrical fill factor	33%	53%



New 15 μm MPPC



HCAL



reflector wrapping machine

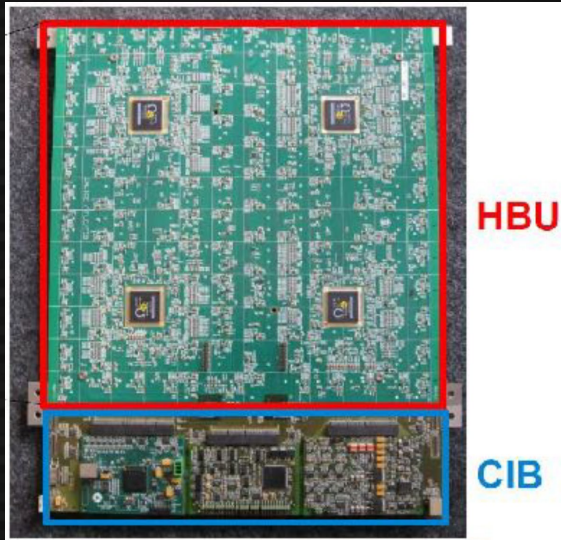


Pick & place machine



Big stack in test beams

Automatic assembly system developed



HBU

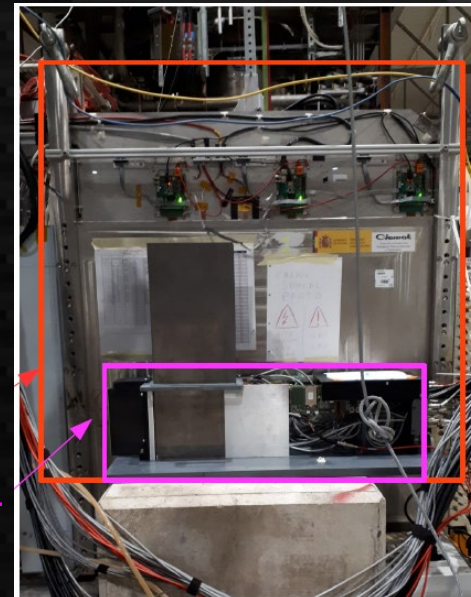
CIB



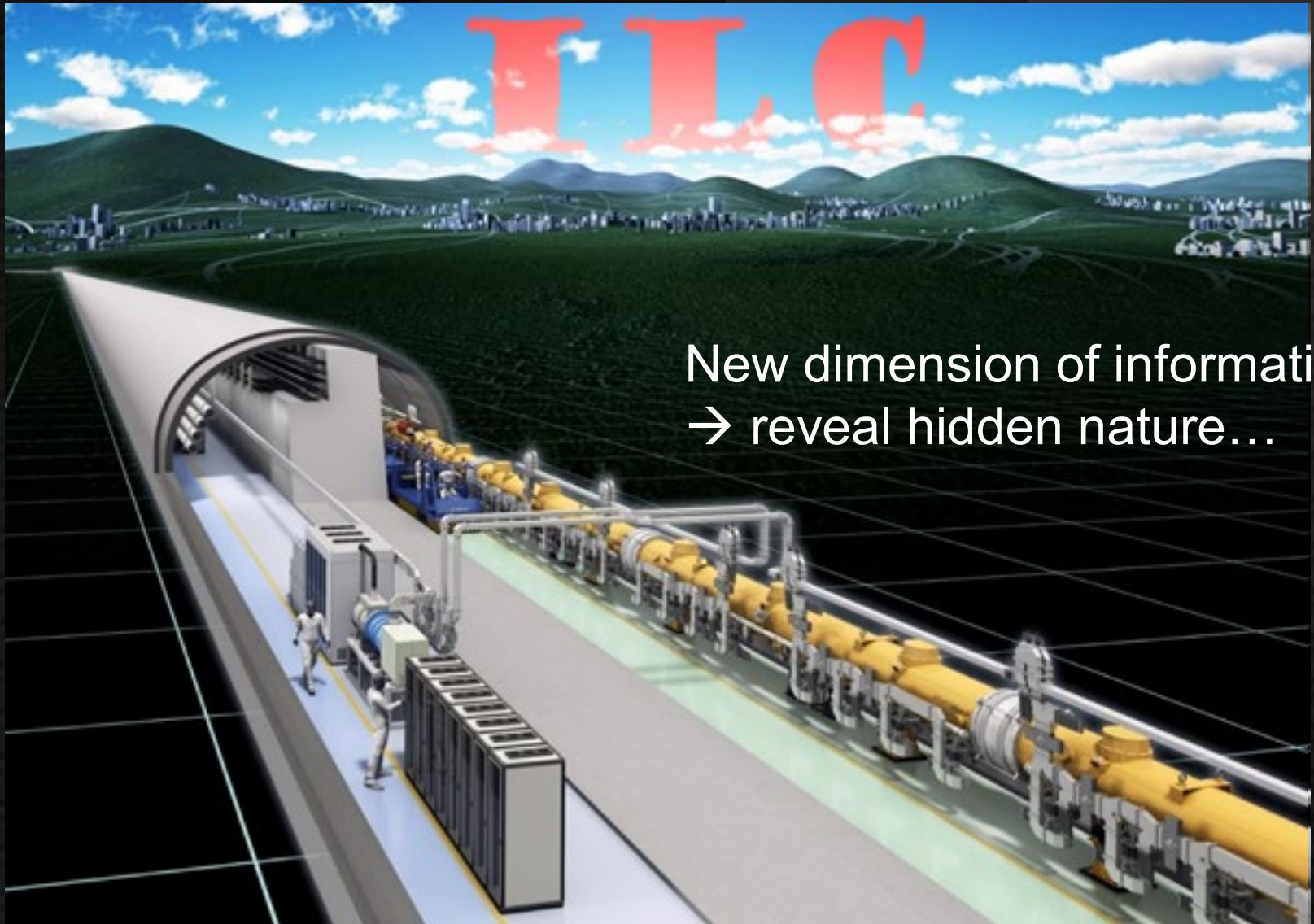
Combined testbeam

SDHCAL

SiW-ECAL



More advanced: 3D to 4D/5D

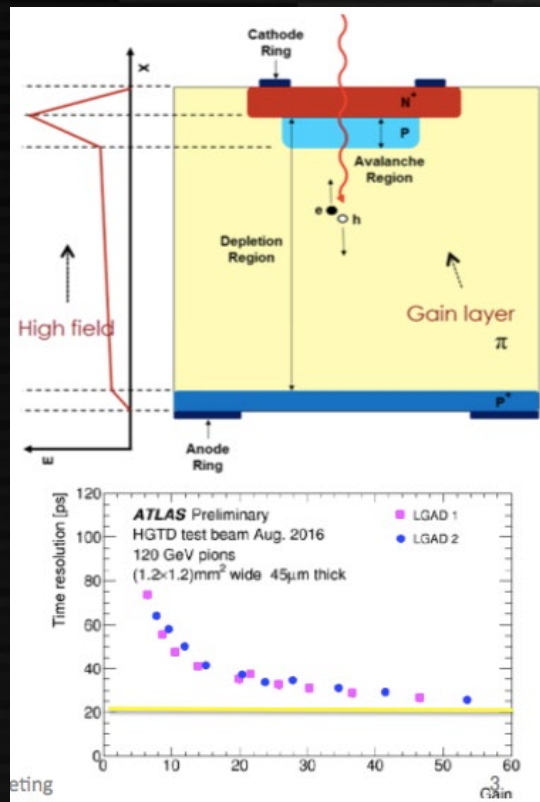
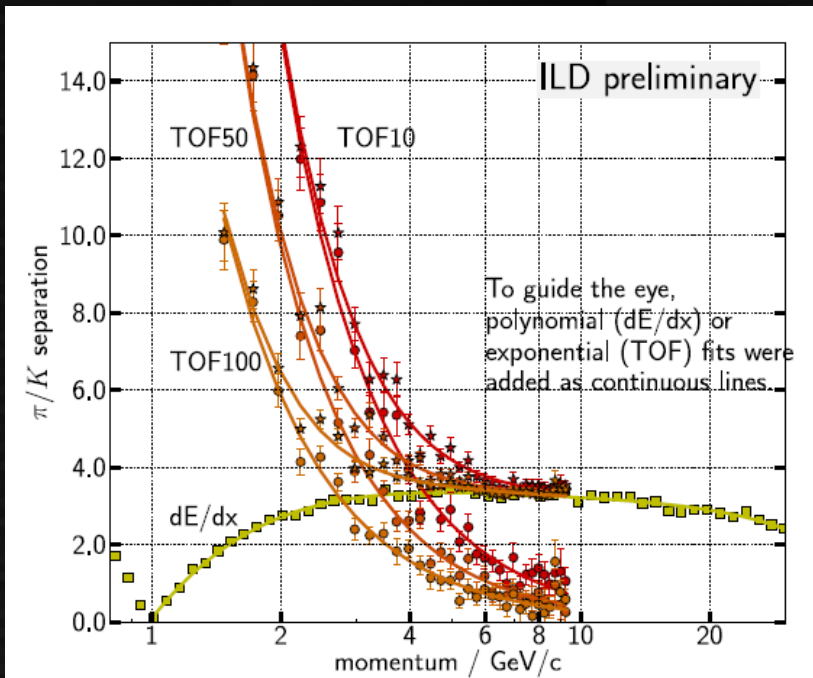


New dimension of information
→ reveal hidden nature...

Particle ID by dE/dx and ToF

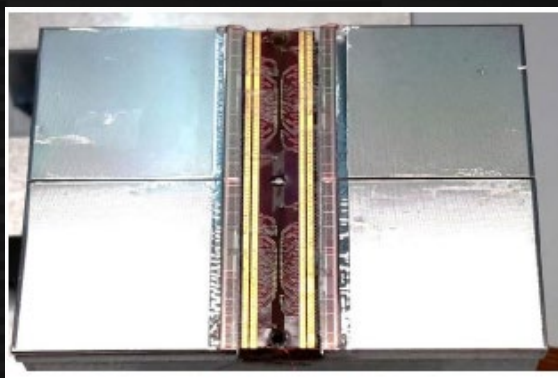
K/ π separation by dE/dx and ToF

- dE/dx: a few – a few tens GeV
- ToF: < 5-10 GeV



Silicon with avalanche gain (LGAD) can be a fast timing detector ~ 20 psec

Studies ongoing



Timepix3 for monolithic TPC readout

Final comments

- We are working hard for the realization of ILC
- Physics case is competitive for all Higgs factories
- Detector technologies are being finalized
 - Need studies on mass production/quality control
 - New ideas are coming and further welcomed
- PFA detector is a “big data” detector
 - Scientists of artificial intelligence are curious
we are trying to get close collaboration with them
- Worldwide support is essential
 - Japan needs clear view for prospects of the project